

BUK9618-55A-VB Datasheet

N-Channel 60-V (D-S) MOSFET

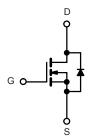
PRODUCT SUMMARY					
V_{DS}	60	V			
$R_{DS(on)} V_{GS} = 10 V$	11	mΩ			
$R_{DS(on)}$ $V_{GS} = 4.5 \text{ V}$	12	mΩ			
I _D	75	Α			
Configuration	Single				

FEATURES

- 175 °C Junction Temperature
- Trench Power MOSFET







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unless othe	rwise noted)			
Parameter	Symbol	Limit	Unit		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 25 °C		75		
	T _C = 100 °C	l _D	50 ^a		
Pulsed Drain Current	I _{DM}	200	Α		
Continuous Source Current (Diode Conduction)	Is	50 ^a			
Avalanche Current		I _{AS}	50	7	
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AS}	125	mJ	
Maximum Payra Dissination	T _C = 25 °C	В	136	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	3 ^b , 8.3 ^{b, c}	W	
Operating Junction and Storage Temperature Range	•	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	R _{thJA}	15	18	°C/W		
	Steady State		40	50			
Maximum Junction-to-Case		R _{thJC}	0.85	1.1			

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. $t \le 10 \text{ s}$.

服务热线:400-655-8788

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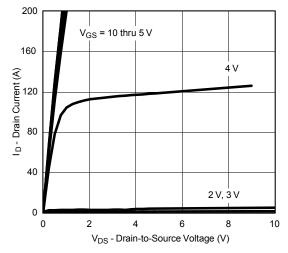
Parameter	Symbol	Test Conditions	Min.		Max.	Unit
Static	<u>'</u>		l	Typ. ^a		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$ 60				V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		3	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V _{DS} = 60 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	60			Α
		V _{GS} = 10 V, I _D = 20 A		0.011		Ω
		V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.016		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.020		
		V _{GS} = 4.5 V, I _D = 15 A		0.012		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S
Dynamic	•					
Input Capacitance	C _{iss}			4300		
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		470		pF
Reverse Transfer Capacitance	C _{rss}			225		
Total Gate Charge ^c	Qg			47		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		10		nC
Gate-Drain Charge ^c	Q_{gd}			12		
Turn-On Delay Time ^c	t _{d(on)}			10	20	
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V, R}_{L} = 0.6 \Omega$		15	25	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		35	50	ns
Fall Time ^c	t _f			20	30	
Source-Drain Diode Ratings and Cha	racteristics (T _C = 25 °C)		·		
Pulsed Current	I _{SM}	60		60	Α	
Diode Forward Voltage	V _{SD}	I _F = 20 A, V _{GS} = 0 V 1 1.5		1.5	V	
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		45	100	ns

- a. For design aid only; not subject to production testing. b. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2~\%$.
- c. Independent of operating temperature.

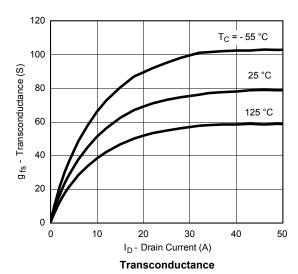
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



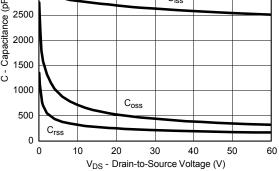
TYPICAL CHARACTERISTICS (25 °C unless noted)



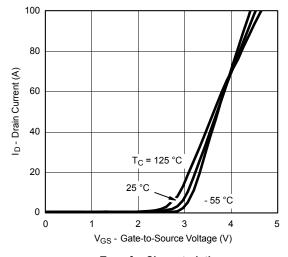
Output Characteristics



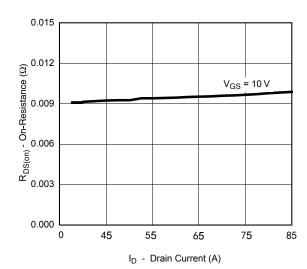
3000 C_{iss} C - Capacitance (pF) 2500 2000 1500



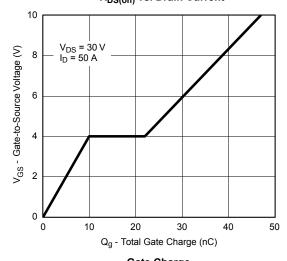
Capacitance



Transfer Characteristics



 $R_{DS(on)}$ vs. Drain Current



Gate Charge

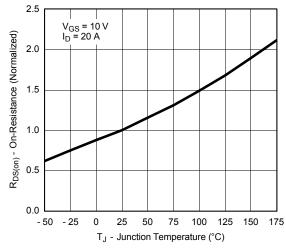
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4000

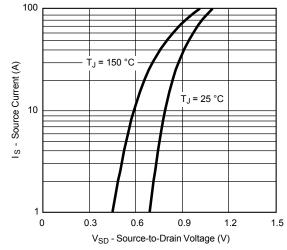
3500



TYPICAL CHARACTERISTICS (25 °C unless noted)



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

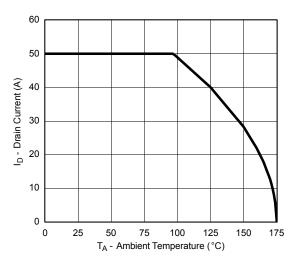
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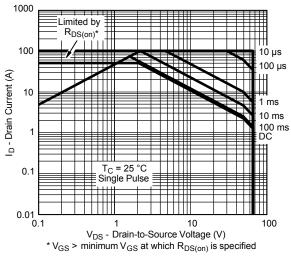
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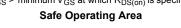
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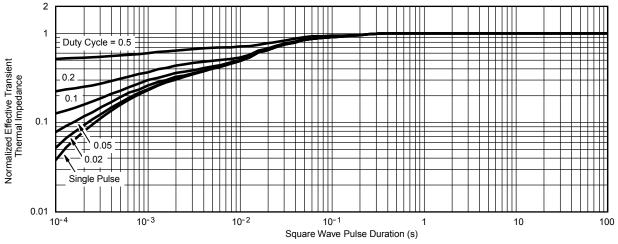
THERMAL RATINGS





Maximum Drain Current vs. Ambient Temperature



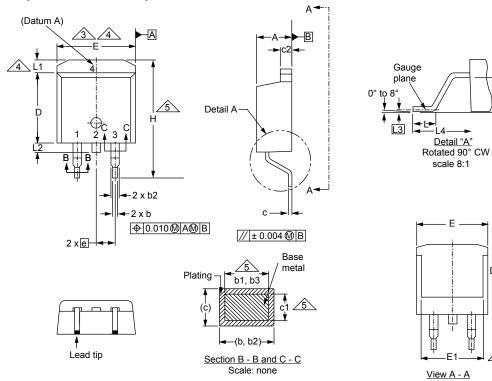


Normalized Thermal Transient Impedance, Junction-to-Case



Seating plane

TO-263AB (HIGH VOLTAGE)



	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.06	4.83	0.160	0.190		
A1	0.00	0.25	0.000	0.010		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035		
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068		
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023		
c2	1.14	1.65	0.045	0.065		
D	8.38	9.65	0.330	0.380		

	MILLIN	MILLIMETERS		HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54	2.54 BSC		BSC
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	-	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

scale 8:1

Ψ

View A - A

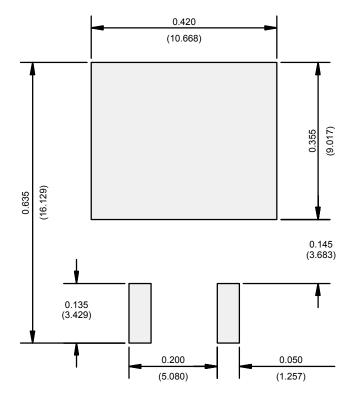
ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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